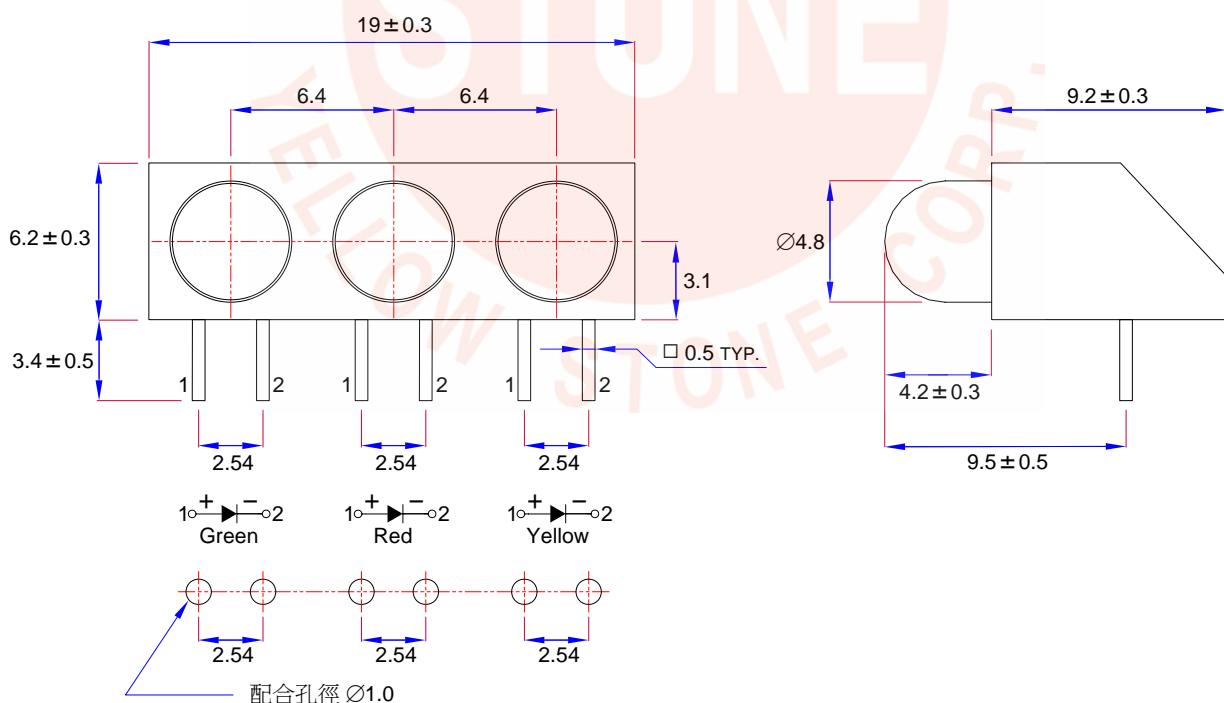




● Features:

1. Chip material: GaP/GaP(G) / GaP/GaP(R) / GaAsP/GaP(Y)
2. Emitted color : Green (48N3BG) / Bright Red (48N3BP) / Yellow (48N3BY)
3. Lens Appearance : Green Diffused / Red Diffused / Yellow Diffused
4. Low power consumption.
5. High efficiency.
6. Versatile mounting on P.C. Board or panel.
7. Low current requirement.
8. 4.8mm diameter package.
9. This product don't contained restriction substance, compliance ROHS standard.

● Package dimensions:



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25 mm ($0.01"$) unless otherwise specified.
3. Lead spacing is measured where the leads emerge from the package.
4. Specifications are subject to change without notice.

● Emitted color : Green

● Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	80	mW
Forward Current	I _F	30	mA
Peak Forward Current	I _{FP}	150	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{Op}	-40°C ~ 85°C	
Storage Temperature	T _{Stg}	-40°C ~ 100°C	
Soldering Temperature	T _{Sol}	260°C max (for 5 seconds)	
Hand Soldering Temperature	T _{Sol}	350°C max(for 3 seconds)	

*¹Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width.

● Electrical and optical characteristics(Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V _F	I _F =10mA	-	2.1	2.5	V
Luminous Intensity	I _V	I _F =10mA	-	35	-	mcd
Reverse Current	I _R	V _R =5V	-	-	100	μA
Peak Wave Length	λ _p	I _F =10mA	-	568	-	nm
Dominant Wave Length	λ _d	I _F =10mA	560	-	576	nm
Spectral Line Half-width	Δλ	I _F =10mA	-	30	-	nm
Viewing Angle	2θ _{1/2}	I _F =10mA	-	40	-	deg



- Emitted color : Green
- Typical electro-optical characteristics curves

Fig.1 Relative intensity vs. Wavelength

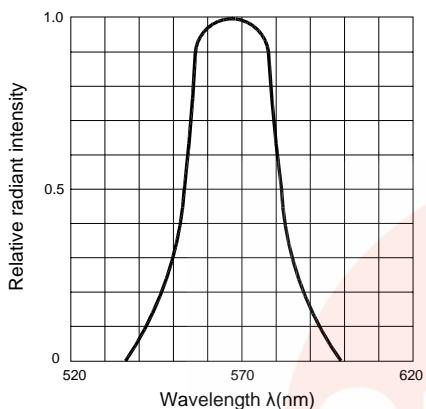


Fig.2 Forward current derating curve
vs. Ambient temperature

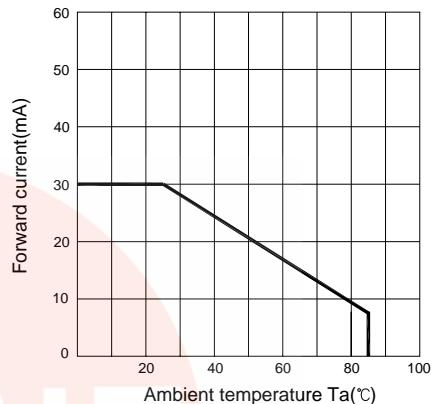


Fig.3 Forward current vs. Forward voltage

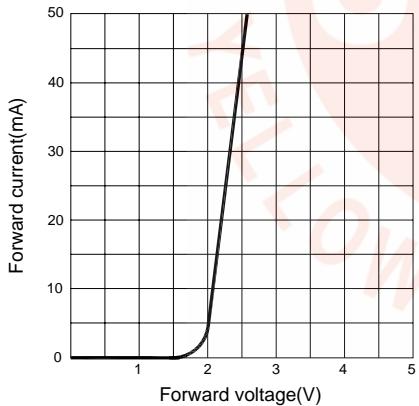


Fig.4 Relative luminous intensity
vs. Ambient temperature

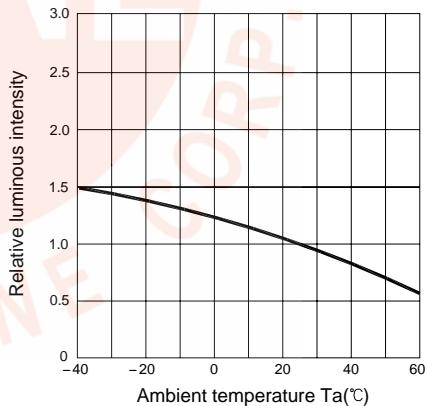


Fig.5 Relative luminous intensity
vs. Forward current

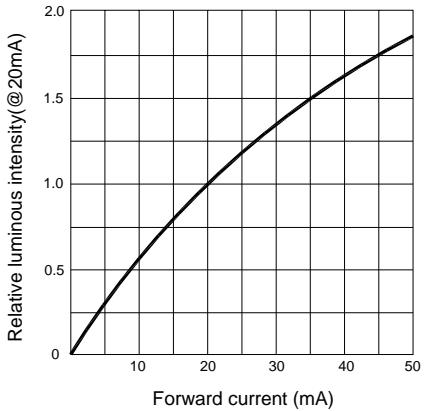
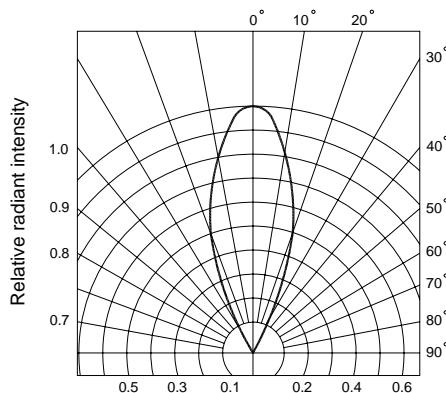


Fig.6 Radiation diagram



● Emitted color : Bright Red

● Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	40	mW
Forward Current	I _F	15	mA
Peak Forward Current ^{*1}	I _{FP}	50	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{Op}	-40°C ~ 85°C	
Storage Temperature	T _{Stg}	-40°C ~ 100°C	
Soldering Temperature	T _{Sol}	260°C max (for 5 seconds)	
Hand Soldering Temperature	T _{Sol}	350°C max(for 3 seconds)	

*¹Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width.

● Electrical and optical characteristics(Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V _F	I _F =10mA	-	2.1	2.5	V
Luminous Intensity	I _V	I _F =10mA	-	3.0	-	mcd
Reverse Current	I _R	V _R =5V	-	-	100	μA
Peak Wave Length	λ _p	I _F =20mA	-	700	-	nm
Dominant Wave Length	λ _d	I _F =20mA	-	650	-	nm
Spectral Line Half-width	Δλ	I _F =20mA	-	100	-	nm
Viewing Angle	2θ _{1/2}	I _F =20mA	-	40	-	deg



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- Emitted color : Bright Red
- Typical electro-optical characteristics curves

Fig.1 Relative intensity vs. Wavelength

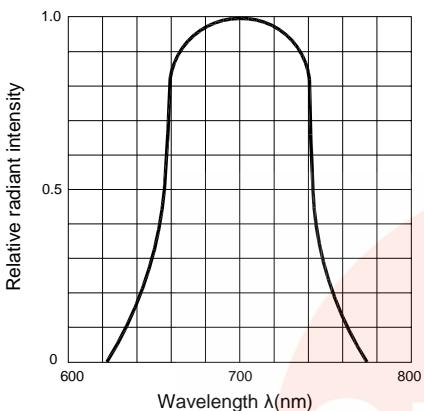


Fig.2 Forward current derating curve
vs. Ambient temperature

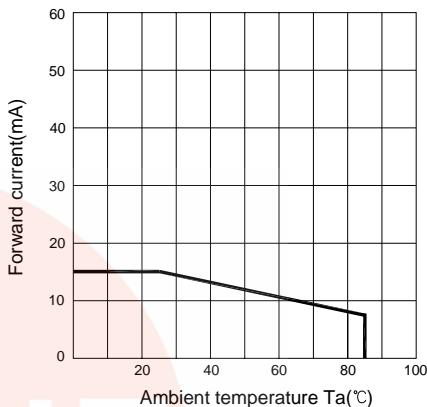


Fig.3 Forward current vs. Forward voltage

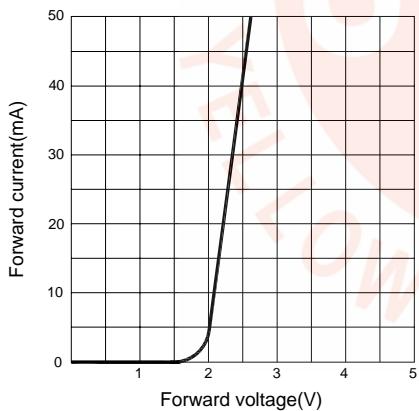


Fig.4 Relative luminous intensity
vs. Ambient temperature

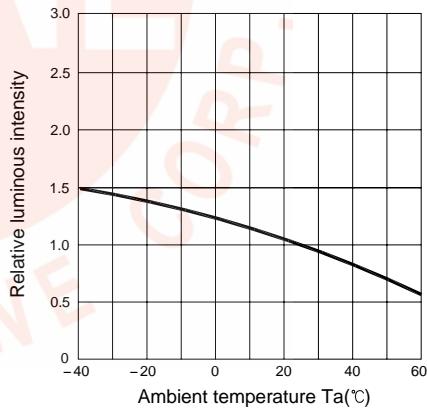


Fig.5 Relative luminous intensity
vs. Forward current

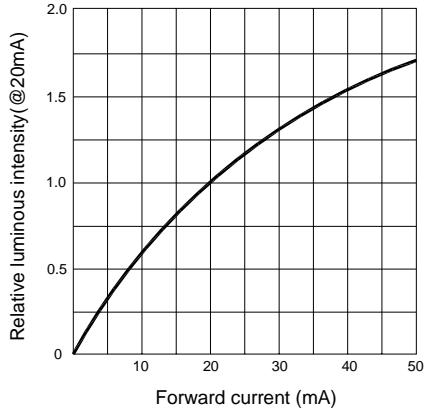
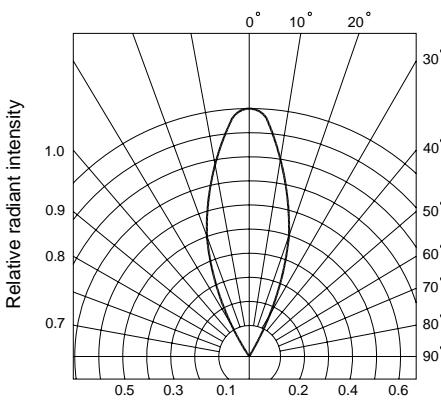


Fig.6 Radiation diagram



● Emitted color : Yellow

● Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	80	mW
Forward Current	I _F	30	mA
Peak Forward Current	I _{FP}	150	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{Op}	-40°C ~ 85°C	
Storage Temperature	T _{Stg}	-40°C ~ 100°C	
Soldering Temperature	T _{Sol}	260°C max(for 5 seconds)	
Hand Soldering Temperature	T _{Sol}	350°C max(for 3 seconds)	

*¹Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width.

● Electrical and optical characteristics(Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V _F	IF=10mA	-	2.0	2.5	V
Luminous Intensity	I _V	IF=10mA	-	30	-	mcd
Reverse Current	I _R	VR=5V	-	-	100	μA
Peak Wave Length	λ _p	IF=10mA	-	585	-	nm
Dominant Wave Length	λ _d	IF=10mA	580	-	595	nm
Spectral Line Half-width	Δλ	IF=10mA	-	35	-	nm
Viewing Angle	2θ _{1/2}	IF=10mA	-	40	-	deg



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YELLOW STONE CORP.

BL-66GRY-3

● Emitted color : Yellow

● Typical Electro-Optical Characteristics Curves

Fig.1 Relative intensity vs. Wavelength

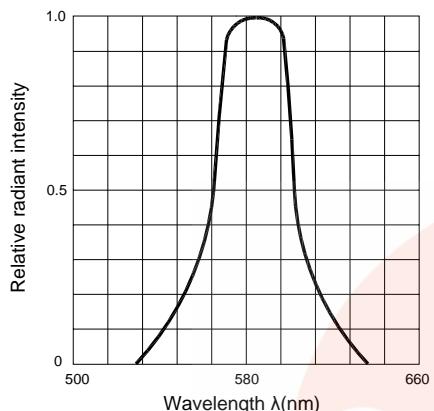


Fig.2 Forward current derating curve
vs. Ambient temperature

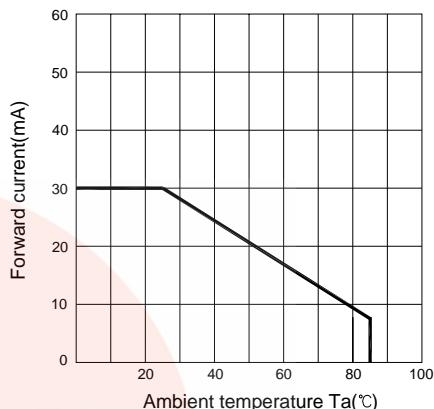


Fig.3 Forward current vs. Forward voltage

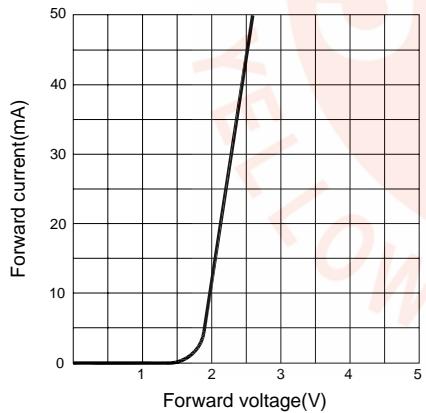


Fig.4 Relative luminous intensity
vs. Ambient temperature

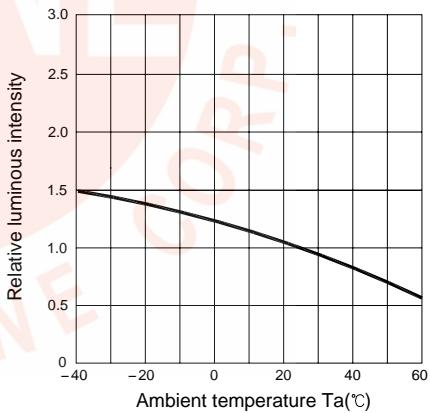


Fig.5 Relative luminous intensity
vs. Forward current

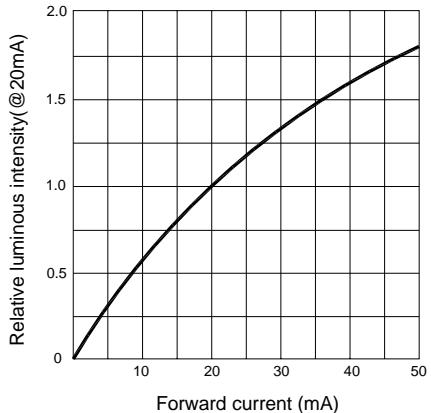
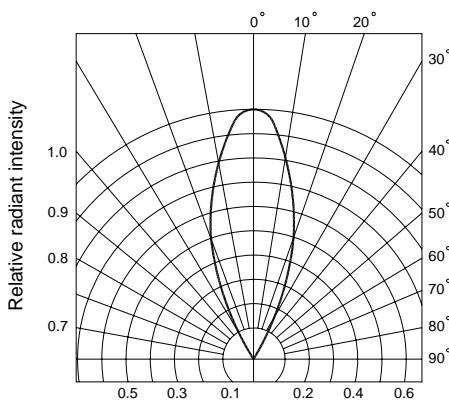
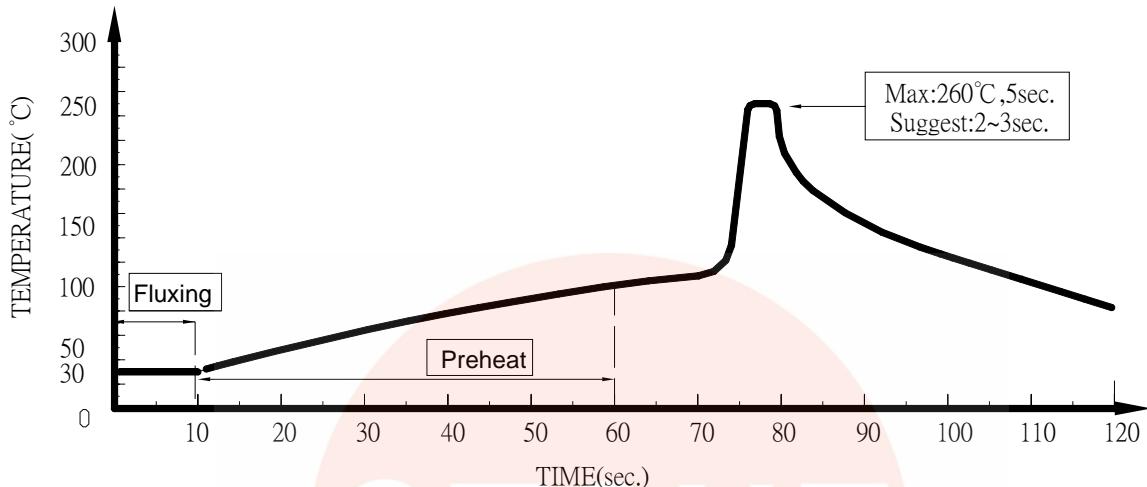


Fig.6 Radiation diagram





● Dip Soldering



1. Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
2. DIP soldering and hand soldering should not be done more than one time.
3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temperature.
4. Avoid rapid cooling during temperature ramp-down process
5. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

● IRON Soldering

A : Max : 350°C Within 3 sec. One time only.

B : For 3mm LED without flange, if the LED epoxy lays flat on the PCB, the welding condition is 350°C within 2 seconds, one time only.

